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63793

Application ID:

10826487

FORMATION OF PROTECTION

LAYER BY DRIPPING DI ON WAFER

WITH HIGH ROTATION TO

Title of Invention:

PREVENT STAIN FORMATION

FROM H2O2/H2SO4 CHEMICAL

SPLASH

First Named Inventor:

BO ZHENG

Domestic/Foreign Application:

Domestic Application

Filing Date:

2004-04-16

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Information Disclosure

Statement

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Attorney Docket Number:

AMAT7589

Total Fees Authorized:

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Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US Certificate Message Digest: 4c733f7c3cdb830e5fb56299fa0125e236328b1c



TRANSMITTAL

Title of Invention

FORMATION OF PROTECTION LAYER BY DRIPPING DI ON WAFER WITH HIGH ROTATION TO PREVENT STAIN FORMATION FROM H2O2/H2SO4 CHEMICAL SPLASH

Application Number:

10/826487

Date:

2004-04-16

First Named Applicant:

BO ZHENG

Confirmation Number:

1358

Attorney Docket Number: AMAT7589

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| Submitted by: | Elec. Sign. | Sign. Capacity |
|--|----------------------|----------------|
| Mr. N. ALEXANDER NOLTE Registered Number: 45689 | [N. ALEXANDER NOLTE] | Attorney |

Documents being submitted

Files

us-ids

AMAT7589NAN-usidst.xml

us-ids.dtd us-ids.xsl

Comments

NO FEES DUE - FILED BEFORE 1ST OA



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

FORMATION OF PROTECTION LAYER BY DRIPPING DI ON WAFER WITH HIGH ROTATION TO PREVENT STAIN FORMATION FROM H2O2/H2SO4 CHEMICAL SPLASH

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Search string:

(4557785 or 5022419 or 5095027 or 5154199 or 5221360 or 5409310 or 6062239 or 6167893 or 6199298 or 6217667 or 6240933 or 6286231 or 6309981 or 6318385 or 6319841 or 6333275 or 6350319 or 6357142 or 6401732 or 6413436 or 6446643 or 6446644 or 6537416 or 6550484 or 6558478 or 6615854 or 20020026729).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

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Remarks

Note: Remarks are not for responding to an office action.

NO FEES DUE - FILED BEFORE 1ST OA

Signature

| Examiner Name | Date |
|---------------|------|
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